



REV.	SPECIFICATION	ECN NO.	APPD.
x5			

Material and Plating:
Housing: LCP, 30% Glass Filled, UL94V-0, BLACK.
Power Contacts: High Conductivity Copper.
 Au(3u")+Pd/Ni (27u") gold plated on Contact Area and 80u" Min Tin Plated on Solder Tail over nickel 50u" Min under plated.
Signal Contacts: Phosphor Bronze.
 Au(3u")+Pd/Ni (27u") gold plated on Contact Area and 80u" Min Tin Plated on Solder Tail over nickel 50u" Min under plated.

Electrical Characteristics:
Current Rating: Signal Pin 2.5 AMP.
 Power Pin 60 AMP.
Dielectric Withstanding Voltage: DC 1500V For 1 minute.
Insulator Resistance: 5000MΩ min. at DC 500V.
Contact Resistance: Signal Pin 30mΩ max.
 Power Pin 0.3mΩ max.
Operating Temperature: -40°C ~+105°C.

***RoHS Compliant**

Notes:
 L: Low Power---PCB Mount 3.0mm Pitch
 D: DC Power---PCB Mount 5.5mm Pitch
 A: AC Power---PCB Mount 7.5mm Pitch

9395- 4 A03 S25 D08 B 7 2 D N G1 A

Series: 9395-
 4: Female Right-angle
 Blank: Without Contact
 Power Contact: Axx, Dxx, Lxx
 No. of position

Blank: Without Contact
 Signal Contact: Sxx
 No. of position

Blank: Without Contact
 Power Contact: Axx, Dxx, Lxx
 No. of position

A: Tray Package
 G1: Guides Top
 N: Without Post
 D: Dip Type
 2: Without Rib
 7: 30u"
 B: Dip Tin Plated
 Contact Au+Pd/Ni Plated

Tolerances	Dwg. No.	9395-D0000-005	Title:		<p>9395 Series Max P60 10mm Low Profile, 60Amp Receptable, Right Angle</p>						
x = ±0.5	Projection		SHEET						1/1	Ver. No.	X5
.x = ±0.25	Unit	mm	Scale						1:1		
.xx = ±0.15	Drawn By	LQ 07/02'16									